



Atty. Dkt. No. 047071-0107

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Harry A. ATWATER, Jr. et al.
Title: WAFER BONDED VIRTUAL
SUBSTRATE AND METHOD
FOR FORMING THE SAME
Appl. No.: 10/761,918
Filing Date: 1/20/2004
Examiner: Duy-Vu DEO
Art Unit: 1765
Confirmation 4108
Number:

AMENDMENT AND REPLY UNDER 37 CFR 1.111

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

This communication is responsive to the Non-Final Office Action dated May 11, 2006, concerning the above-referenced patent application.

Amendments to the Specification begin on page 2 of this document.

Amendments to the Claims are reflected in the listing of claims which begins on page 3 of this document.

Remarks/Arguments begin on page 8 of this document.

Please amend the application as follows: